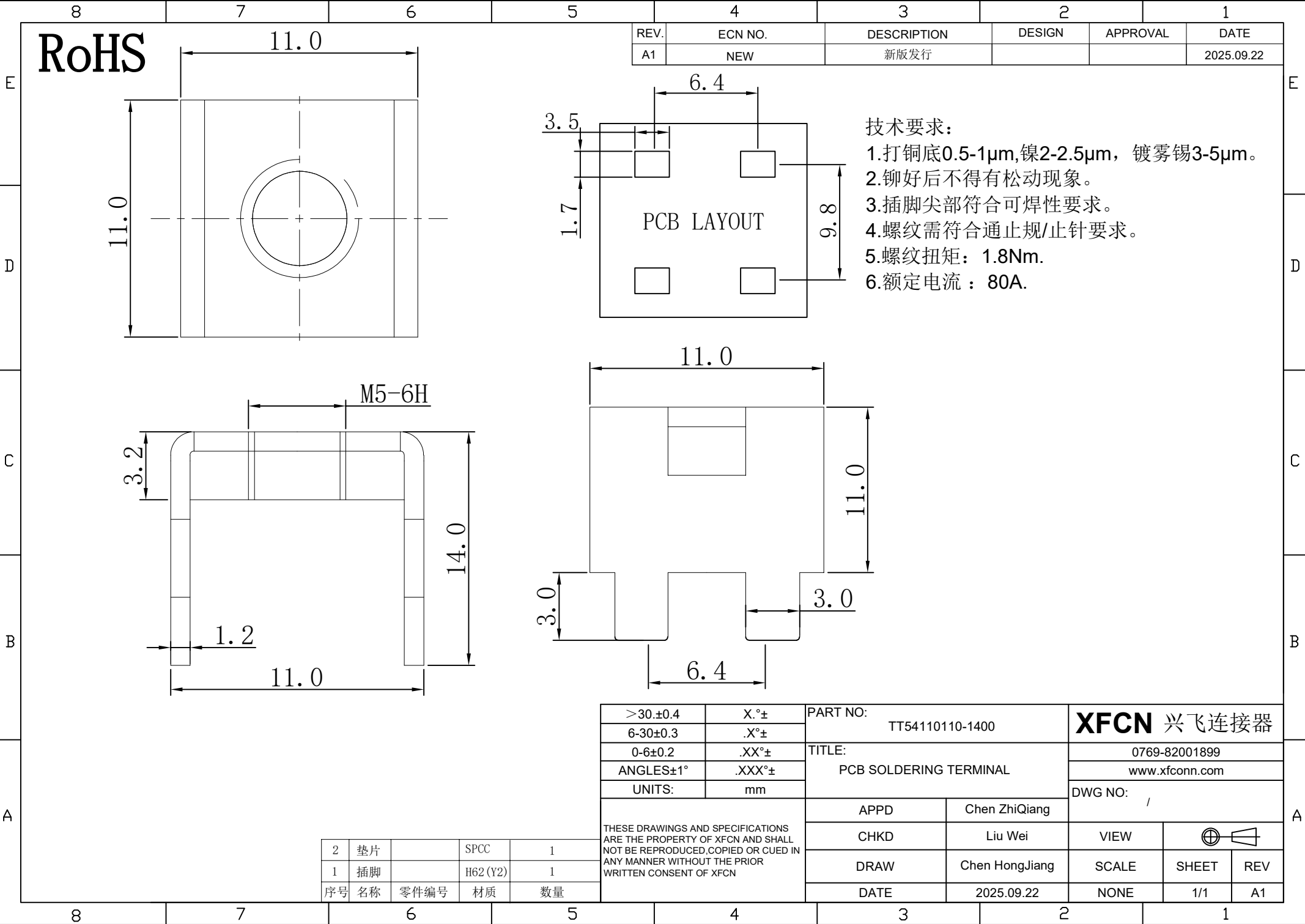




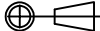
RoHS

REV.	ECN NO.	DESCRIPTION	DESIGN	APPROVAL	DATE
A1	NEW	新版发行			2025.09.22

PCB LAYOUT

- 技术要求:
- 1.打铜底0.5-1μm,镍2-2.5μm, 镀雾锡3-5μm。
 - 2.铆好后不得有松动现象。
 - 3.插脚尖部符合可焊性要求。
 - 4.螺纹需符合通止规/止针要求。
 - 5.螺纹扭矩：1.8Nm.
 - 6.额定电流：80A.

2	垫片		SPCC	1
1	插脚		H62 (Y2)	1
序号	名称	零件编号	材质	数量

>30.±0.4	X.°±	PART NO: TT54110110-1400		XFCN 兴飞连接器			
6-30±0.3	.X°±						
0-6±0.2	.XX°±	TITLE: PCB SOLDERING TERMINAL		0769-82001899			
ANGLES±1°	.XXX°±			www.xfconn.com			
UNITS:	mm	THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF XFCN AND SHALL NOT BE REPRODUCED, COPIED OR CUED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT OF XFCN		DWG NO: /			
APPD				Chen ZhiQiang			
CHKD				Liu Wei		VIEW	
DRAW				Chen HongJiang		SCALE	SHEET
DATE		2025.09.22		NONE		1/1	A1